IN THE CLAIMS

Please amend claims 20-24, as follows:

1 1-19. (Canceled)

- 1 20. (currently amended) An apparatus for etching a tapered trench in a layer of material, 2 said layer of material having a mask on adjacent a surface thereof, said mask having an opening 3 defining a location on the layer of material at which the trench is to be formed, said apparatus 4 comprising: 5 an etching tool adapted to enlarge for performing vertical etch process steps on 6 said layer of material; and 7 an opening enlarging tool adapted to enlarge for performing steps of enlarging 8 said opening in said mask, said etching tool and said opening enlarging tool adapting to operate 9 operating in an alternating manner in order to form a trench of a desired depth in said layer of 10 material.
- 21. (currently amended) The apparatus according to Claim 20, wherein said mask 2 comprises a resist layer, and wherein said mask opening enlarging tool is adapted to perform 3 comprises a tool for performing resist layer etching etch process steps on said resist layer.
- 1 22. (currently amended) The apparatus according to Claim 21, wherein said resist layer 2 is tapered around a the periphery of said opening, to facilitate performing of the resist etch 3 process steps.

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- 23. (currently amended) The apparatus according to Claim 20, 21, wherein said etching vertical etch process tool and said opening enlarging resist etch process tool are incorporated in a tool that operates in a pulsed manner.
- 24. (currently amended) The apparatus according to Claim 20 21, wherein said etching vertical etch process tool and said opening enlarging resist etch process tool are incorporated in a tool that operates in a multi step manner.